IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re U.S. Patent Application of   )

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SHIMAMOTO *et al.*   )

)

Application Number: 10/020,314   )

)

Filed: December 18, 2001   )

)

For: FABRICATING METHOD OF SEMICONDUCTOR   )

       INTEGRATED CIRCUITS   )

)

ATTORNEY DOCKET NO. HITA.0143   )

Art unit: 2823

Examiner:

NGUYEN, KHIEM D.

**Honorable Assistant Commissioner
for Patents
Washington, D.C. 20231**

COVER LETTER

Sir:

[ ]   The fee for submission of additional claims is calculated as shown below:

FOR	TOTAL WITH NEW CLAIMS ADDED	TOTAL CURRENTLY ON FILE	CLAIMS PAID	RATE	CALCULATION
Total Claims	20	20	(Over 20)	x $18	0
Independent Claims	2	2	(Over 3)	x $84	0
MULTIPLE DEPENDENT CLAIM(S)				+ $280	0
REDUCTION FOR FILING BY SMALL ENTITY (note 37 C.F.R. §§ 1.9, 1.27, 1.28). IF APPLICABLE, VERIFIED STATEMENT MUST BE ATTACHED				x ½	
			TOTAL		0.00

In addition, the below-identified communications are submitted in the above-captioned application or proceeding:

[x] Response to Office Action   [ ] Petition for Extension of Time
       (with Claim Amendments)   [ ] Terminal Disclaimer
[ ] Preliminary Amendment   [ ] Letter to Draftsperson
[ ] Substitute Specification   [ ] Assignment
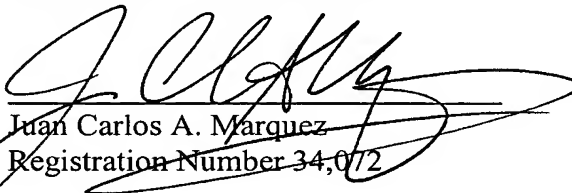[ ] Other _____   [ ] Petition under _____

[ ] Please charge my **Deposit Account Number** _____ in the amount of _____ to cover the fees for
_____. A duplicate copy of this paper is enclosed.

[ ] A check in the amount of **$0.00** to cover the fee is enclosed.

[x] The Commissioner is hereby authorized to charge any additional fees associated with this communication,
including patent application filing fees and processing fees under 37 C.F.R. § 1.16 and 1.17, or credit any
overpayment to **Deposit Account Number 08-1480.**

Respectfully submitted,

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